AMENDMENTS TO THE SPECIFICATION

Kindly replace the original specification and abstract with the enclosed substitute specification and abstract.

Please insert the heading -- BACKGROUND OF THE INVENTION --, in line 5 on page 1 of the specification.

Please replace the heading "[TECHNICAL FIELD]," with --I. Technical Field-- in line 6 on page 1 of the specification.

Please replace the heading "[BACKGROUND ART]," with --II. Description of the Related Art-- in line 15 on page 1 of the specification.

Please amend paragraph [0003] beginning on page 2, line 1 and ending at line 13, as follows:

Previously, various ideas have been proposed for the protection panel. For example, Japanese Laid-Open Patent Publication No. 2002-72214 discloses such a constitution that, in order to solve ~~such a~~the disadvantage ~~that~~of a liquid crystal display [[is]] having extremely poor [[in]] viewability in well-lit rooms and outdoors due to reflection, a protection panel is formed in a combination of a $\lambda/4$ plate, a polarizing plate, and a transparent protective plate. Such arts are also disclosed ~~that~~having additional functions ~~are~~ added to the outermost surface of the protection panel by constructing the transparent protective plate as a touch panel and sticking a hard coating film or a low reflectance film thereon.

Please amend paragraph [0004] beginning on page 2, line 1 and ending at line 13, as follows:

Moreover, recently, as electronic apparatuses have become fashionable in design,[[a]] decoration, such as edging, has been [[is]] made on the protection panel by printing as disclosed in Japanese Laid-Open Patent Publication No. 2001-318612.

Please cancel the heading "[Patent document 1] Japanese Laid-Open Patent Publication No. 2002-72214" in lines 19 and 20 on page 2 of the specification.

Please cancel the heading "[Patent document 2] Japanese Laid-Open Patent Publication No. 2001-318612" in lines 21 and 22 on page 2 of the specification.

Please replace the heading "[DISCLOSURE OF THE INVENTION]," with -- SUMMARY OF THE INVENTION -- in line 23 on page 2 of the specification.

Please cancel the heading "[Problems to be Solved by the Invention]" in line 24 on page 2 of the specification.

Please amend paragraph [0005] beginning on page 2, line 26 and ending on page 3 at line 4, as follows:

However, to print a decoration on the protection panel, printing has to be carried out on each of the formed protection panels after forming the protection panel. Therefore, there is ~~such~~ a problem that the above is disadvantageous in productivity.

Please cancel the heading "[Means for Solving the Problem]" in line 11 on page 3 of the specification.

Please amend paragraph [0007] beginning on page 3, line 12 and ending at line 19, as follows:

To achieve the above object, according to a first aspect of the present invention,[[A]]a display window protection panel for an electronic apparatus fitted into a display window opening for protecting a portion of a display device, which is located under the display window opening in a casing of the electronic apparatus and exposed from the display window opening, the protection panel comprising:

Please replace the heading "[BRIEF DESCRIPTION OF DRAWING]," with -- BRIEF DESCRIPTION OF THE DRAWINGS-- in line 25 on page 8 of the specification.

Please replace the heading "[BEST MODE FOR CARRYING OUT THE INVENTION]," with --DETAILED DESCRIPTION OF THE INVENTION-- in line 3 on page 10 of the specification.

Please amend paragraph [0027] beginning on page 13, line 3 and ending at line 18, as follows:

For the transparent protective plate 4, a material that excels in transparency and is capable of protecting the liquid crystal panel 15 from ~~breakeage~~breakage is used. For example, general-purpose resins such as polystyrene resin, polyolefin resin, ABS resin, AS resin, acrylic resin, and AN resin, and the like are given. Moreover, the following resins may be used: general-purpose engineering resins such as polystyrene resin, polycarbonate resin, polyacetal resin, polycarbonate denatured polyphenylene ether resin, polybutylene terephthalate resin, and ultra high molecular weight polyethylene resin, and the like; or super engineering resins such as polysulfone resin, polyphenylene sulfide resin, polyphenylene oxide resin, polyarylate resin, polyetherimide resin, polyimide resin, liquid crystal polyester resin, and polyallyl heat-resistant resin, and the like.